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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	C166
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, EBI/EMI, SPI, SSC, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	59
Program Memory Size	64KB (64K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	4.75V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	PG-MQFP-80-7
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/c164ci8emcbkxuma1

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Table 2 Pin Definitions and Functions

Symbol	Pin No.	Input Outp.	Function		
P5		I	Port 5 is an 8-bit input-only port with Schmitt-Trigger charact. The pins of Port 5 also serve as analog input channels for the A/D converter, or they serve as timer inputs:		
P5.0	76	I	AN0		
P5.1	77	I	AN1		
P5.2	78	I	AN2		
P5.3	79	I	AN3		
P5.4	2	I	AN4,	T2EUD	GPT1 Timer T2 Ext. Up/Down Ctrl. Inp.
P5.5	3	I	AN5,	T4EUD	GPT1 Timer T4 Ext. Up/Down Ctrl. Inp.
P5.6	4	I	AN6,	T2IN	GPT1 Timer T2 Input for Count/Gate/Reload/Capture
P5.7	5	I	AN7,	T4IN	GPT1 Timer T4 Input for Count/Gate/Reload/Capture
P3		IO	Port 3 is a 9-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 3 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 3 is selectable (TTL or special). The following Port 3 pins also serve for alternate functions:		
P3.4	8	I	T3EUD	GPT1 Timer T3 External Up/Down Control Input	
P3.6	9	I	T3IN	GPT1 Timer T3 Count/Gate Input	
P3.8	10	I/O	MRST	SSC Master-Receive/Slave-Transmit Inp./Outp.	
P3.9	11	I/O	MTSR	SSC Master-Transmit/Slave-Receive Outp./Inp.	
P3.10	12	O	TxD0	ASC0 Clock/Data Output (Async./Sync.)	
P3.11	13	I/O	RxD0	ASC0 Data Input (Async.) or Inp./Outp. (Sync.)	
P3.12	14	O	$\overline{\text{BHE}}$	External Memory High Byte Enable Signal,	
		O	$\overline{\text{WRH}}$	External Memory High Byte Write Strobe	
P3.13	15	I/O	SCLK	SSC Master Clock Output / Slave Clock Input.	
P3.15	16	O	CLKOUT	System Clock Output (= CPU Clock),	
		O	FOUT	Programmable Frequency Output	

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin No.	Input Outp.	Function
$\overline{EA}/V_{PP}$	28	I	External Access Enable pin. **A low level** at this pin during and after Reset forces the C164CI to latch the configuration from PORT0 and pin $\overline{RD}$, and to begin instruction execution out of external memory. **A high level** forces the C164CI to latch the configuration from pins $\overline{RD}$ and ALE, and to begin instruction execution out of the internal program memory. "ROMless" versions must have this pin tied to '0'. *Note: This pin also accepts the programming voltage for the OTP derivatives.*
PORT0 P0L.0-7 P0H.0-7	 29-36 37-39, 42-46	IO	PORT0 consists of the two 8-bit bidirectional I/O ports P0L and P0H. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. In case of an external bus configuration, PORT0 serves as the address (A) and address/data (AD) bus in multiplexed bus modes and as the data (D) bus in demultiplexed bus modes. **Demultiplexed bus modes:** Data Path Width: 8-bit 16-bit P0L.0 – P0L.7: D0 – D7 D0 – D7 P0H.0 – P0H.7: I/O D8 – D15 **Multiplexed bus modes:** Data Path Width: 8-bit 16-bit P0L.0 – P0L.7: AD0 – AD7 AD0 – AD7 P0H.0 – P0H.7: A8 – A15 AD8 – AD15

The C164CI also provides an excellent mechanism to identify and to process exceptions or error conditions that arise during run-time, so-called ‘Hardware Traps’. Hardware traps cause immediate non-maskable system reaction which is similar to a standard interrupt service (branching to a dedicated vector table location). The occurence of a hardware trap is additionally signified by an individual bit in the trap flag register (TFR). Except when another higher prioritized trap service is in progress, a hardware trap will interrupt any actual program execution. In turn, hardware trap services can normally not be interrupted by standard or PEC interrupts.

Table 4 shows all of the possible exceptions or error conditions that can arise during run-time:

Table 4 Hardware Trap Summary

Exception Condition	Trap Flag	Trap Vector	Vector Location	Trap Number	Trap Priority
Reset Functions: – Hardware Reset – Software Reset – W-dog Timer Overflow	–	 RESET RESET RESET	 $00'0000_H$ $00'0000_H$ $00'0000_H$	 00_H 00_H 00_H	 III III III
Class A Hardware Traps: – Non-Maskable Interrupt – Stack Overflow – Stack Underflow	 NMI STKOF STKUF	 NMITRAP STOTRAP STUTRAP	 $00'0008_H$ $00'0010_H$ $00'0018_H$	 02_H 04_H 06_H	 II II II
Class B Hardware Traps: – Undefined Opcode – Protected Instruction Fault – Illegal Word Operand Access – Illegal Instruction Access – Illegal External Bus Access	 UNDOPC PRTFLT ILLOPA ILLINA ILLBUS	 BTRAP BTRAP BTRAP BTRAP BTRAP	 $00'0028_H$ $00'0028_H$ $00'0028_H$ $00'0028_H$ $00'0028_H$	 $0A_H$ $0A_H$ $0A_H$ $0A_H$ $0A_H$	 I I I I I
Reserved	–	–	$[2C_H – 3C_H]$	$[0B_H – 0F_H]$	–
Software Traps – TRAP Instruction	–	–	Any $[00'0000_H – 00'01FC_H]$ in steps of 4_H	Any $[00_H – 7F_H]$	Current CPU Priority

A/D Converter

For analog signal measurement, a 10-bit A/D converter with 8 multiplexed input channels and a sample and hold circuit has been integrated on-chip. It uses the method of successive approximation. The sample time (for loading the capacitors) and the conversion time is programmable and can so be adjusted to the external circuitry.

Overrun error detection/protection is provided for the conversion result register (ADDAT): either an interrupt request will be generated when the result of a previous conversion has not been read from the result register at the time the next conversion is complete, or the next conversion is suspended in such a case until the previous result has been read.

For applications which require less than 8 analog input channels, the remaining channel inputs can be used as digital input port pins.

The A/D converter of the C164CI supports four different conversion modes. In the standard Single Channel conversion mode, the analog level on a specified channel is sampled once and converted to a digital result. In the Single Channel Continuous mode, the analog level on a specified channel is repeatedly sampled and converted without software intervention. In the Auto Scan mode, the analog levels on a prespecified number of channels (standard or extension) are sequentially sampled and converted. In the Auto Scan Continuous mode, the number of prespecified channels is repeatedly sampled and converted. In addition, the conversion of a specific channel can be inserted (injected) into a running sequence without disturbing this sequence. This is called Channel Injection Mode.

The Peripheral Event Controller (PEC) may be used to automatically store the conversion results into a table in memory for later evaluation, without requiring the overhead of entering and exiting interrupt routines for each data transfer.

After each reset and also during normal operation the ADC automatically performs calibration cycles. This automatic self-calibration constantly adjusts the converter to changing operating conditions (e.g. temperature) and compensates process variations.

These calibration cycles are part of the conversion cycle, so they do not affect the normal operation of the A/D converter.

In order to decouple analog inputs from digital noise and to avoid input trigger noise those pins used for analog input can be disconnected from the digital IO or input stages under software control. This can be selected for each pin separately via register P5DIDIS (Port 5 Digital Input Disable).

Parallel Ports

The C164CI provides up to 59 I/O lines which are organized into five input/output ports and one input port. All port lines are bit-addressable, and all input/output lines are individually (bit-wise) programmable as inputs or outputs via direction registers. The I/O ports are true bidirectional ports which are switched to high impedance state when configured as inputs. The output drivers of three I/O ports can be configured (pin by pin) for push/pull operation or open-drain operation via control registers. During the internal reset, all port pins are configured as inputs.

The input threshold of Port 3, Port 4, and Port 8 is selectable (TTL or CMOS like), where the special CMOS like input threshold reduces noise sensitivity due to the input hysteresis. The input threshold may be selected individually for each byte of the respective ports.

All port lines have programmable alternate input or output functions associated with them. All port lines that are not used for these alternate functions may be used as general purpose IO lines.

PORT0 and PORT1 may be used as address and data lines when accessing external memory, while Port 4 outputs the additional segment address bits A21/19/17 … A16 and the optional chip select signals in systems where segmentation is enabled to access more than 64 KBytes of memory.
Ports P1L, P1H, and P8 are associated with the capture inputs or compare outputs of the CAPCOM units and/or serve as external interrupt inputs.
Port 3 includes alternate functions of timers, serial interfaces, the optional bus control signal $\overline{\text{BHE}}$/$\overline{\text{WRH}}$, and the system clock output CLKOUT (or the programmable frequency output FOUT).
Port 5 is used for the analog input channels to the A/D converter or timer control signals.

The edge characteristics (transition time) and driver characteristics (output current) of the C164CI's port drivers can be selected via the Port Output Control registers (POCONx).

Power Management

The C164CI provides several means to control the power it consumes either at a given time or averaged over a certain timespan. Three mechanisms can be used (partly in parallel):

- **Power Saving Modes** switch the C164CI into a special operating mode (control via instructions).
  Idle Mode stops the CPU while the peripherals can continue to operate.
  Sleep Mode and Power Down Mode stop all clock signals and all operation (RTC may optionally continue running). Sleep Mode can be terminated by external interrupt signals.
- **Clock Generation Management** controls the distribution and the frequency of internal and external clock signals (control via register SYSCON2).
  Slow Down Mode lets the C164CI run at a CPU clock frequency of f_{OSC}/1 … 32 (half for prescaler operation) which drastically reduces the consumed power. The PLL can be optionally disabled while operating in Slow Down Mode.
  External circuitry can be controlled via the programmable frequency output FOUT.
- **Peripheral Management** permits temporary disabling of peripheral modules (control via register SYSCON3).
  Each peripheral can separately be disabled/enabled. A group control option disables a major part of the peripheral set by setting one single bit.

The on-chip RTC supports intermittend operation of the C164CI by generating cyclic wakeup signals. This offers full performance to quickly react on action requests while the intermittend sleep phases greatly reduce the average power consumption of the system.

Special Function Registers Overview

Table 7 lists all SFRs which are implemented in the C164CI in alphabetical order. **Bit-addressable** SFRs are marked with the letter "**b**" in column "Name". SFRs within the **Extended SFR-Space** (ESFRs) are marked with the letter "**E**" in column "Physical Address". Registers within on-chip X-peripherals are marked with the letter "**X**" in column "Physical Address".

An SFR can be specified via its individual mnemonic name. Depending on the selected addressing mode, an SFR can be accessed via its physical address (using the Data Page Pointers), or via its short 8-bit address (without using the Data Page Pointers).

Table 7 C164CI Registers, Ordered by Name

Name	Physical Address	8-Bit Addr.	Description	Reset Value
ADCIC b	$FF98_H$	CC_H	A/D Converter End of Conversion Interrupt Control Register	0000_H
ADCON b	$FFA0_H$	$D0_H$	A/D Converter Control Register	0000_H
ADDAT	$FEA0_H$	50_H	A/D Converter Result Register	0000_H
ADDAT2	$F0A0_H$ **E**	50_H	A/D Converter 2 Result Register	0000_H
ADDRSEL1	$FE18_H$	$0C_H$	Address Select Register 1	0000_H
ADDRSEL2	$FE1A_H$	$0D_H$	Address Select Register 2	0000_H
ADDRSEL3	$FE1C_H$	$0E_H$	Address Select Register 3	0000_H
ADDRSEL4	$FE1E_H$	$0F_H$	Address Select Register 4	0000_H
ADEIC b	$FF9A_H$	CD_H	A/D Converter Overrun Error Interrupt Control Register	0000_H
BUSCON0 b	$FF0C_H$	86_H	Bus Configuration Register 0	0000_H
BUSCON1 b	$FF14_H$	$8A_H$	Bus Configuration Register 1	0000_H
BUSCON2 b	$FF16_H$	$8B_H$	Bus Configuration Register 2	0000_H
BUSCON3 b	$FF18_H$	$8C_H$	Bus Configuration Register 3	0000_H
BUSCON4 b	$FF1A_H$	$8D_H$	Bus Configuration Register 4	0000_H
C1BTR	$EF04_H$ **X**	---	CAN1 Bit Timing Register	$UUUU_H$
C1CSR	$EF00_H$ **X**	---	CAN1 Control / Status Register	$XX01_H$
C1GMS	$EF06_H$ **X**	---	CAN1 Global Mask Short	$UFUU_H$
C1LARn	$EFn4_H$ **X**	---	CAN Lower Arbitration Register (msg. **n)**	$UUUU_H$
C1LGML	$EF0A_H$ **X**	---	CAN Lower Global Mask Long	$UUUU_H$
C1LMLM	$EF0E_H$ **X**	---	CAN Lower Mask of Last Message	$UUUU_H$

Table 7 C164CI Registers, Ordered by Name (cont'd)

Name		Physical Address		8-Bit Addr.	Description	Reset Value
CTCON	**b**	$FF30_H$		98_H	CAPCOM 6 Compare Timer Ctrl. Reg.	1010_H
DP0H	**b**	$F102_H$	**E**	81_H	P0H Direction Control Register	00_H
DP0L	**b**	$F100_H$	**E**	80_H	P0L Direction Control Register	00_H
DP1H	**b**	$F106_H$	**E**	83_H	P1H Direction Control Register	00_H
DP1L	**b**	$F104_H$	**E**	82_H	P1L Direction Control Register	00_H
DP3	**b**	$FFC6_H$		$E3_H$	Port 3 Direction Control Register	0000_H
DP4	**b**	$FFCA_H$		$E5_H$	Port 4 Direction Control Register	00_H
DP8	**b**	$FFD6_H$		EB_H	Port 8 Direction Control Register	00_H
DPP0		$FE00_H$		00_H	CPU Data Page Pointer 0 Reg. (10 bits)	0000_H
DPP1		$FE02_H$		01_H	CPU Data Page Pointer 1 Reg. (10 bits)	0001_H
DPP2		$FE04_H$		02_H	CPU Data Page Pointer 2 Reg. (10 bits)	0002_H
DPP3		$FE06_H$		03_H	CPU Data Page Pointer 3 Reg. (10 bits)	0003_H
EXICON	**b**	$F1C0_H$	**E**	$E0_H$	External Interrupt Control Register	0000_H
EXISEL	**b**	$F1DA_H$	**E**	ED_H	External Interrupt Source Select Reg.	0000_H
FOCON	**b**	$FFAA_H$		$D5_H$	Frequency Output Control Register	0000_H
IDCHIP		$F07C_H$	**E**	$3E_H$	Identifier	$XXXX_H$
IDMANUF		$F07E_H$	**E**	$3F_H$	Identifier	1820_H
IDMEM		$F07A_H$	**E**	$3D_H$	Identifier	$XXXX_H$
IDPROG		$F078_H$	**E**	$3C_H$	Identifier	$XXXX_H$
IDMEM2		$F076_H$	**E**	$3B_H$	Identifier	$XXXX_H$
ISNC	**b**	$F1DE_H$	**E**	EF_H	Interrupt Subnode Control Register	0000_H
MDC	**b**	$FF0E_H$		87_H	CPU Multiply Divide Control Register	0000_H
MDH		$FE0C_H$		06_H	CPU Multiply Divide Reg. – High Word	0000_H
MDL		$FE0E_H$		07_H	CPU Multiply Divide Reg. – Low Word	0000_H
ODP3	**b**	$F1C6_H$	**E**	$E3_H$	Port 3 Open Drain Control Register	0000_H
ODP4	**b**	$F1CA_H$	**E**	$E5_H$	Port 4 Open Drain Control Register	00_H
ODP8	**b**	$F1D6_H$	**E**	EB_H	Port 8 Open Drain Control Register	00_H
ONES	**b**	$FF1E_H$		$8F_H$	Constant Value 1's Register (read only)	$FFFF_H$
OPAD		$EDC2_H$	**X**	---	OTP Progr. Interface Address Register	0000_H
OPCTRL		$EDC0_H$	**X**	---	OTP Progr. Interface Control Register	0007_H

Table 7 C164CI Registers, Ordered by Name (cont'd)

Name	Physical Address	8-Bit Addr.	Description	Reset Value
OPDAT	$EDC4_H$ **X**	---	OTP Progr. Interface Data Register	0000_H
P0H b	$FF02_H$	81_H	Port 0 High Reg. (Upper half of PORT0)	00_H
P0L b	$FF00_H$	80_H	Port 0 Low Reg. (Lower half of PORT0)	00_H
P1H b	$FF06_H$	83_H	Port 1 High Reg. (Upper half of PORT1)	00_H
P1L b	$FF04_H$	82_H	Port 1 Low Reg. (Lower half of PORT1)	00_H
P3 b	$FFC4_H$	$E2_H$	Port 3 Register	0000_H
P4 b	$FFC8_H$	$E4_H$	Port 4 Register (7 bits)	00_H
P5 b	$FFA2_H$	$D1_H$	Port 5 Register (read only)	$XXXX_H$
P5DIDIS b	$FFA4_H$	$D2_H$	Port 5 Digital Input Disable Register	0000_H
P8 b	$FFD4_H$	EA_H	Port 8 Register (8 bits)	00_H
PECC0	$FEC0_H$	60_H	PEC Channel 0 Control Register	0000_H
PECC1	$FEC2_H$	61_H	PEC Channel 1 Control Register	0000_H
PECC2	$FEC4_H$	62_H	PEC Channel 2 Control Register	0000_H
PECC3	$FEC6_H$	63_H	PEC Channel 3 Control Register	0000_H
PECC4	$FEC8_H$	64_H	PEC Channel 4 Control Register	0000_H
PECC5	$FECA_H$	65_H	PEC Channel 5 Control Register	0000_H
PECC6	$FECC_H$	66_H	PEC Channel 6 Control Register	0000_H
PECC7	$FECE_H$	67_H	PEC Channel 7 Control Register	0000_H
PICON b	$F1C4_H$ **E**	$E2_H$	Port Input Threshold Control Register	0000_H
POCON0H	$F082_H$ **E**	41_H	Port P0H Output Control Register	0011_H
POCON0L	$F080_H$ **E**	40_H	Port P0L Output Control Register	0011_H
POCON1H	$F086_H$ **E**	43_H	Port P1H Output Control Register	0011_H
POCON1L	$F084_H$ **E**	42_H	Port P1L Output Control Register	0011_H
POCON20	$F0AA_H$ **E**	55_H	Dedicated Pin Output Control Register	0000_H
POCON3	$F08A_H$ **E**	45_H	Port P3 Output Control Register	2222_H
POCON4	$F08C_H$ **E**	46_H	Port P4 Output Control Register	0010_H
POCON8	$F092_H$ **E**	49_H	Port P8 Output Control Register	0022_H
PSW b	$FF10_H$	88_H	CPU Program Status Word	0000_H
RP0H b	$F108_H$ **E**	84_H	System Startup Config. Reg. (Rd. only)	XX_H
RSTCON b	$F1E0_H$ **m**	---	Reset Control Register	$00XX_H$

Table 7 C164CI Registers, Ordered by Name (cont'd)

Name		Physical Address		8-Bit Addr.	Description	Reset Value
T12IC	**b**	$F190_H$	**E**	$C8_H$	CAPCOM 6 Timer 12 Interrupt Ctrl. Reg.	0000_H
T12OF		$F034_H$	**E**	$1A_H$	CAPCOM 6 Timer 12 Offset Register	0000_H
T12P		$F030_H$	**E**	18_H	CAPCOM 6 Timer 12 Period Register	0000_H
T13IC	**b**	$F198_H$	**E**	CC_H	CAPCOM 6 Timer 13 Interrupt Ctrl. Reg.	0000_H
T13P		$F032_H$	**E**	19_H	CAPCOM 6 Timer 13 Period Register	0000_H
T14		$F0D2_H$	**E**	69_H	RTC Timer 14 Register	no
T14REL		$F0D0_H$	**E**	68_H	RTC Timer 14 Reload Register	no
T2		$FE40_H$		20_H	GPT1 Timer 2 Register	0000_H
T2CON	**b**	$FF40_H$		$A0_H$	GPT1 Timer 2 Control Register	0000_H
T2IC	**b**	$FF60_H$		$B0_H$	GPT1 Timer 2 Interrupt Control Register	0000_H
T3		$FE42_H$		21_H	GPT1 Timer 3 Register	0000_H
T3CON	**b**	$FF42_H$		$A1_H$	GPT1 Timer 3 Control Register	0000_H
T3IC	**b**	$FF62_H$		$B1_H$	GPT1 Timer 3 Interrupt Control Register	0000_H
T4		$FE44_H$		22_H	GPT1 Timer 4 Register	0000_H
T4CON	**b**	$FF44_H$		$A2_H$	GPT1 Timer 4 Control Register	0000_H
T4IC	**b**	$FF64_H$		$B2_H$	GPT1 Timer 4 Interrupt Control Register	0000_H
T7		$F050_H$	**E**	28_H	CAPCOM Timer 7 Register	0000_H
T78CON	**b**	$FF20_H$		90_H	CAPCOM Timer 7 and 8 Ctrl. Reg.	0000_H
T7IC	**b**	$F17A_H$	**E**	BD_H	CAPCOM Timer 7 Interrupt Ctrl. Reg.	0000_H
T7REL		$F054_H$	**E**	$2A_H$	CAPCOM Timer 7 Reload Register	0000_H
T8		$F052_H$	**E**	29_H	CAPCOM Timer 8 Register	0000_H
T8IC	**b**	$F17C_H$	**E**	BE_H	CAPCOM Timer 8 Interrupt Ctrl. Reg.	0000_H
T8REL		$F056_H$	**E**	$2B_H$	CAPCOM Timer 8 Reload Register	0000_H
TFR	**b**	$FFAC_H$		$D6_H$	Trap Flag Register	0000_H
TRCON	**b**	$FF34_H$		$9A_H$	CAPCOM 6 Trap Enable Ctrl. Reg.	$00XX_H$
WDT		$FEAE_H$		57_H	Watchdog Timer Register (read only)	0000_H
WDTCON		$FFAE_H$		$D7_H$	Watchdog Timer Control Register	[2] $00xx_H$
XP0IC	**b**	$F186_H$	**E**	$C3_H$	CAN1 Module Interrupt Control Register	0000_H
XP1IC	**b**	$F18E_H$	**E**	$C7_H$	Unassigned Interrupt Control Reg.	0000_H

Absolute Maximum Ratings

Table 8 Absolute Maximum Rating Parameters

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Storage temperature	T_{ST}	-65	150	°C	–
Junction temperature	T_J	-40	150	°C	under bias
Voltage on V_{DD} pins with respect to ground (V_{SS})	V_{DD}	-0.5	6.5	V	–
Voltage on any pin with respect to ground (V_{SS})	V_{IN}	-0.5	V_{DD} + 0.5	V	–
Input current on any pin during overload condition	–	-10	10	mA	–
Absolute sum of all input currents during overload condition	–	–	|100|	mA	–
Power dissipation	P_{DISS}	–	1.5	W	–

Note: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
During absolute maximum rating overload conditions ($V_{IN} > V_{DD}$ or $V_{IN} < V_{SS}$) the voltage on V_{DD} pins with respect to ground (V_{SS}) must not exceed the values defined by the absolute maximum ratings.

Table 10 Current Limits for Port Output Drivers

Port Output Driver Mode	Maximum Output Current (I_{OLmax}, $-I_{OHmax}$)[1]	Nominal Output Current (I_{OLnom}, $-I_{OHnom}$)[2]
Strong driver	10 mA	2.5 mA
Medium driver	4.0 mA	1.0 mA
Weak driver	0.5 mA	0.1 mA

1) An output current above $|I_{OXnom}|$ may be drawn from up to three pins at the same time. For any group of 16 neighboring port output pins the total output current in each direction (ΣI_{OL} and $\Sigma -I_{OH}$) must remain below 50 mA.

2) The current ROM-version of the C164CI (step Ax) is equipped with port drivers, which provide reduced driving capability and reduced control. Please refer to the actual errata sheet for details.

Power Consumption C164CI (ROM)

(Operating Conditions apply)

Parameter	Sym-bol	Limit Values		Unit	Test Conditions
		min.	max.		
Power supply current (active) with all peripherals active	I_{DD}	–	1 + 2.5 × f_{CPU}	mA	$\overline{RSTIN}$ = V_{IL} f_{CPU} in [MHz][1]
Idle mode supply current with all peripherals active	I_{IDX}	–	1 + 1.1 × f_{CPU}	mA	$\overline{RSTIN}$ = V_{IH1} f_{CPU} in [MHz][1]
Idle mode supply current with all peripherals deactivated, PLL off, SDD factor = 32	I_{IDO}[2]	–	500 + 50 × f_{OSC}	µA	$\overline{RSTIN}$ = V_{IH1} f_{OSC} in [MHz][1]
Sleep and Power-down mode supply current with RTC running	I_{PDR}[2]	–	200 + 25 × f_{OSC}	µA	V_{DD} = V_{DDmax} f_{OSC} in [MHz][3]
Sleep and Power-down mode supply current with RTC disabled	I_{PDO}	–	50	µA	V_{DD} = V_{DDmax}[3]

1) The supply current is a function of the operating frequency. This dependency is illustrated in **Figure 9**. These parameters are tested at V_{DDmax} and maximum CPU clock with all outputs disconnected and all inputs at V_{IL} or V_{IH}.

2) This parameter is determined mainly by the current consumed by the oscillator (see **Figure 8**). This current, however, is influenced by the external oscillator circuitry (crystal, capacitors). The values given refer to a typical circuitry and may change in case of a not optimized external oscillator circuitry.

3) This parameter is tested including leakage currents. All inputs (including pins configured as inputs) at 0 V to 0.1 V or at V_{DD} - 0.1 V to V_{DD}, V_{REF} = 0 V, all outputs (including pins configured as outputs) disconnected.

Power Consumption C164CI (OTP)

(Operating Conditions apply)

Parameter	Symbol	Limit Values		Unit	Test Conditions
		min.	max.		
Power supply current (active) with all peripherals active	I_{DD}	–	10 + 3.5 × f_{CPU}	mA	$\overline{RSTIN}$ = V_{IL} f_{CPU} in [MHz] [1]
Idle mode supply current with all peripherals active	I_{IDX}	–	5 + 1.25 × f_{CPU}	mA	$\overline{RSTIN}$ = V_{IH1} f_{CPU} in [MHz] [1]
Idle mode supply current with all peripherals deactivated, PLL off, SDD factor = 32	I_{IDO} [2]	–	500 + 50 × f_{OSC}	µA	$\overline{RSTIN}$ = V_{IH1} f_{OSC} in [MHz] [1]
Sleep and Power-down mode supply current with RTC running	I_{PDR} [2]	–	200 + 25 × f_{OSC}	µA	V_{DD} = V_{DDmax} f_{OSC} in [MHz] [3]
Sleep and Power-down mode supply current with RTC disabled	I_{PDO}	–	50	µA	V_{DD} = V_{DDmax} [3]

1) The supply current is a function of the operating frequency. This dependency is illustrated in **Figure 10**. These parameters are tested at V_{DDmax} and maximum CPU clock with all outputs disconnected and all inputs at V_{IL} or V_{IH}.

2) This parameter is determined mainly by the current consumed by the oscillator (see **Figure 8**). This current, however, is influenced by the external oscillator circuitry (crystal, capacitors). The values given refer to a typical circuitry and may change in case of a not optimized external oscillator circuitry.

3) This parameter is tested including leakage currents. All inputs (including pins configured as inputs) at 0 V to 0.1 V or at V_{DD} - 0.1 V to V_{DD}, V_{REF} = 0 V, all outputs (including pins configured as outputs) disconnected.

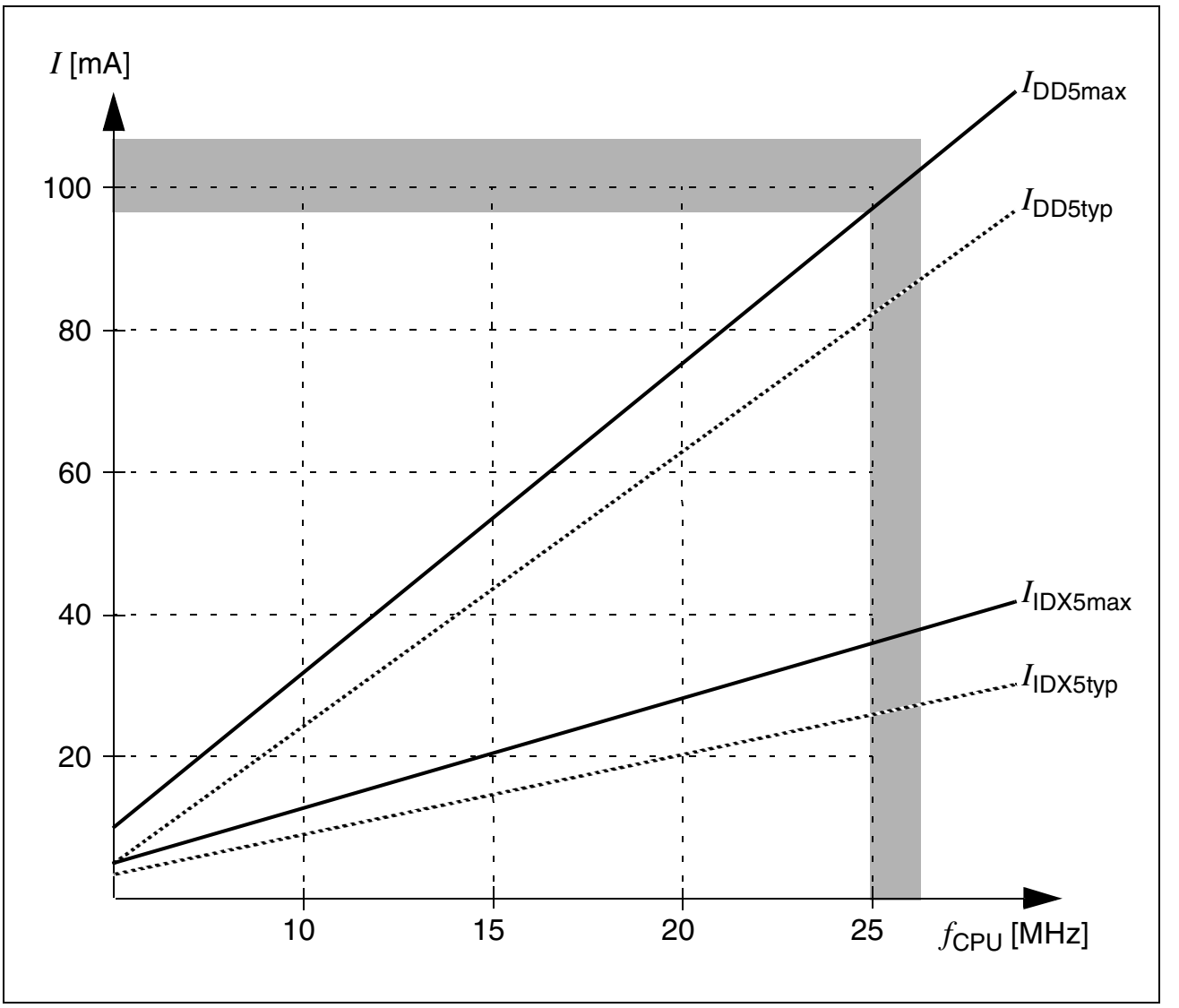

Figure 10 Supply/Idle Current as a Function of Operating Frequency for OTP Derivatives

A/D Converter Characteristics

(Operating Conditions apply)

Table 13 A/D Converter Characteristics

Parameter	Symbol		Limit Values		Unit	Test Conditions
			min.	max.		
Analog reference supply	V_{AREF}	SR	4.0	V_{DD} + 0.1	V	[1]
Analog reference ground	V_{AGND}	SR	V_{SS} - 0.1	V_{SS} + 0.2	V	–
Analog input voltage range	V_{AIN}	SR	V_{AGND}	V_{AREF}	V	[2]
Basic clock frequency	f_{BC}		0.5	6.25	MHz	[3]
Conversion time	t_C	CC	–	40 t_{BC} + t_S + 2t_{CPU}	–	[4] $t_{CPU} = 1 / f_{CPU}$
Calibration time after reset	t_{CAL}	CC	–	3328 t_{BC}	–	[5]
Total unadjusted error	TUE	CC	–	±2	LSB	[1]
Internal resistance of reference voltage source	R_{AREF}	SR	–	t_{BC} / 60 - 0.25	kΩ	t_{BC} in [ns][6][7]
Internal resistance of analog source	R_{ASRC}	SR	–	t_S / 450 - 0.25	kΩ	t_S in [ns][7][8]
ADC input capacitance	C_{AIN}	CC	–	33	pF	[7]

1) TUE is tested at V_{AREF} = 5.0 V, V_{AGND} = 0 V, V_{DD} = 4.9 V. It is guaranteed by design for all other voltages within the defined voltage range.
If the analog reference supply voltage exceeds the power supply voltage by up to 0.2 V (i.e. V_{AREF} = V_{DD} = +0.2 V) the maximum TUE is increased to ±3 LSB. This range is not 100% tested.
The specified TUE is guaranteed only if the absolute sum of input overload currents on Port 5 pins (see I_{OV} specification) does not exceed 10 mA.
During the reset calibration sequence the maximum TUE may be ±4 LSB.

2) V_{AIN} may exceed V_{AGND} or V_{AREF} up to the absolute maximum ratings. However, the conversion result in these cases will be $X000_H$ or $X3FF_H$, respectively.

3) The limit values for f_{BC} must not be exceeded when selecting the CPU frequency and the ADCTC setting.

4) This parameter includes the sample time t_S, the time for determining the digital result and the time to load the result register with the conversion result.
Values for the basic clock t_{BC} depend on programming and can be taken from **Table 14**.
This parameter depends on the ADC control logic. It is not a real maximum value, but rather a fixum.

5) During the reset calibration conversions can be executed (with the current accuracy). The time required for these conversions is added to the total reset calibration time.

6) During the conversion the ADC's capacitance must be repeatedly charged or discharged. The internal resistance of the reference voltage source must allow the capacitance to reach its respective voltage level within each conversion step. The maximum internal resistance results from the programmed conversion timing.

7) Not 100% tested, guaranteed by design and characterization.

Multiplexed Bus (cont'd)
(Operating Conditions apply)
ALE cycle time = 6 TCL + $2t_A + t_C + t_F$ (120 ns at 25 MHz CPU clock without waitstates)

Parameter	Symbol		Max. CPU Clock = 25 MHz		Variable CPU Clock 1 / 2TCL = 1 to 25 MHz		Unit
			min.	max.	min.	max.	
$\overline{RD}$, $\overline{WR}$ low time (no RW-delay)	t_{13}	CC	50 + t_C	–	3TCL - 10 + t_C	–	ns
$\overline{RD}$ to valid data in (with RW-delay)	t_{14}	SR	–	20 + t_C	–	2TCL - 20 + t_C	ns
$\overline{RD}$ to valid data in (no RW-delay)	t_{15}	SR	–	40 + t_C	–	3TCL - 20 + t_C	ns
ALE low to valid data in	t_{16}	SR	–	40 + t_A + t_C	–	3TCL - 20 + t_A + t_C	ns
Address to valid data in	t_{17}	SR	–	50 + $2t_A$ + t_C	–	4TCL - 30 + $2t_A$ + t_C	ns
Data hold after $\overline{RD}$ rising edge	t_{18}	SR	0	–	0	–	ns
Data float after $\overline{RD}$	t_{19}	SR	–	26 + t_F	–	2TCL - 14 + t_F	ns
Data valid to $\overline{WR}$	t_{22}	CC	20 + t_C	–	2TCL - 20 + t_C	–	ns
Data hold after $\overline{WR}$	t_{23}	CC	26 + t_F	–	2TCL - 14 + t_F	–	ns
ALE rising edge after $\overline{RD}$, $\overline{WR}$	t_{25}	CC	26 + t_F	–	2TCL - 14 + t_F	–	ns
Address hold after $\overline{RD}$, $\overline{WR}$	t_{27}	CC	26 + t_F	–	2TCL - 14 + t_F	–	ns
ALE falling edge to $\overline{CS}$[1)]	t_{38}	CC	-4 - t_A	10 - t_A	-4 - t_A	10 - t_A	ns
$\overline{CS}$ low to Valid Data In[1)]	t_{39}	SR	–	40 + t_C + $2t_A$	–	3TCL - 20 + t_C + $2t_A$	ns
$\overline{CS}$ hold after $\overline{RD}$, $\overline{WR}$[1)]	t_{40}	CC	46 + t_F	–	3TCL - 14 + t_F	–	ns
ALE fall. edge to $\overline{RdCS}$, $\overline{WrCS}$ (with RW delay)	t_{42}	CC	16 + t_A	–	TCL - 4 + t_A	–	ns

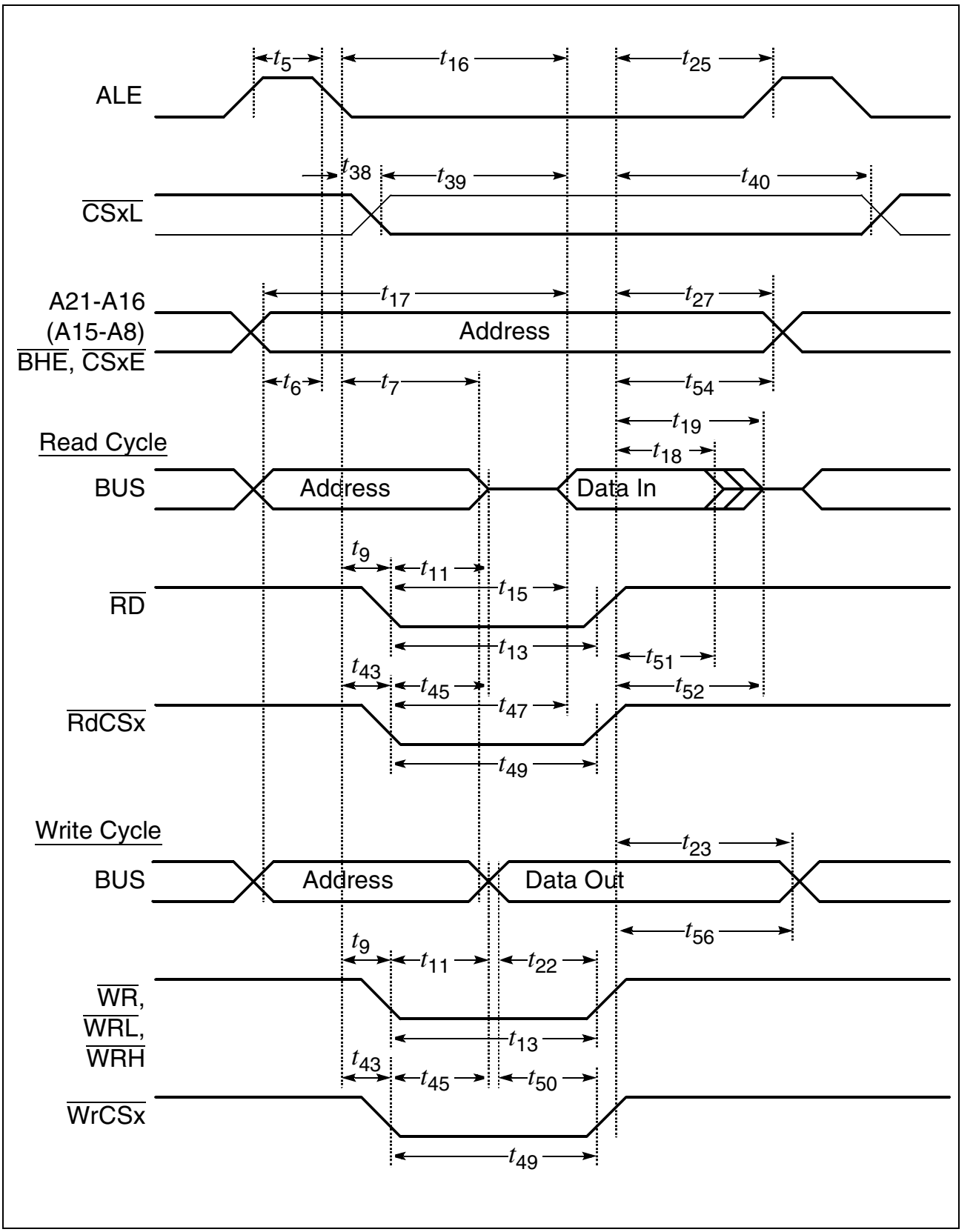

Figure 18 External Memory Cycle:
Multiplexed Bus, No Read/Write Delay, Normal ALE

AC Characteristics

Demultiplexed Bus

(Operating Conditions apply)
ALE cycle time = 4 TCL + $2t_A + t_C + t_F$ (80 ns at 25 MHz CPU clock without waitstates)

Parameter	Symbol		Max. CPU Clock = 25 MHz		Variable CPU Clock 1 / 2TCL = 1 to 25 MHz		Unit
			min.	max.	min.	max.	
ALE high time	t_5	CC	10 + t_A	–	TCL - 10 + t_A	–	ns
Address setup to ALE	t_6	CC	4 + t_A	–	TCL - 16 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (with RW-delay)	t_8	CC	10 + t_A	–	TCL - 10 + t_A	–	ns
ALE falling edge to $\overline{RD}$, $\overline{WR}$ (no RW-delay)	t_9	CC	-10 + t_A	–	-10 + t_A	–	ns
$\overline{RD}$, $\overline{WR}$ low time (with RW-delay)	t_{12}	CC	30 + t_C	–	2TCL - 10 + t_C	–	ns
$\overline{RD}$, $\overline{WR}$ low time (no RW-delay)	t_{13}	CC	50 + t_C	–	3TCL - 10 + t_C	–	ns
$\overline{RD}$ to valid data in (with RW-delay)	t_{14}	SR	–	20 + t_C	–	2TCL - 20 + t_C	ns
$\overline{RD}$ to valid data in (no RW-delay)	t_{15}	SR	–	40 + t_C	–	3TCL - 20 + t_C	ns
ALE low to valid data in	t_{16}	SR	–	40 + t_A + t_C	–	3TCL - 20 + t_A + t_C	ns
Address to valid data in	t_{17}	SR	–	50 + $2t_A$ + t_C	–	4TCL - 30 + $2t_A$ + t_C	ns
Data hold after $\overline{RD}$ rising edge	t_{18}	SR	0	–	0	–	ns
Data float after $\overline{RD}$ rising edge (with RW-delay[1)])	t_{20}	SR	–	26 + $2t_A$ + t_F[1)]	–	2TCL - 14 + $22t_A$ + t_F[1)]	ns
Data float after $\overline{RD}$ rising edge (no RW-delay[1)])	t_{21}	SR	–	10 + $2t_A$ + t_F[1)]	–	TCL - 10 + $22t_A$ + t_F[1)]	ns

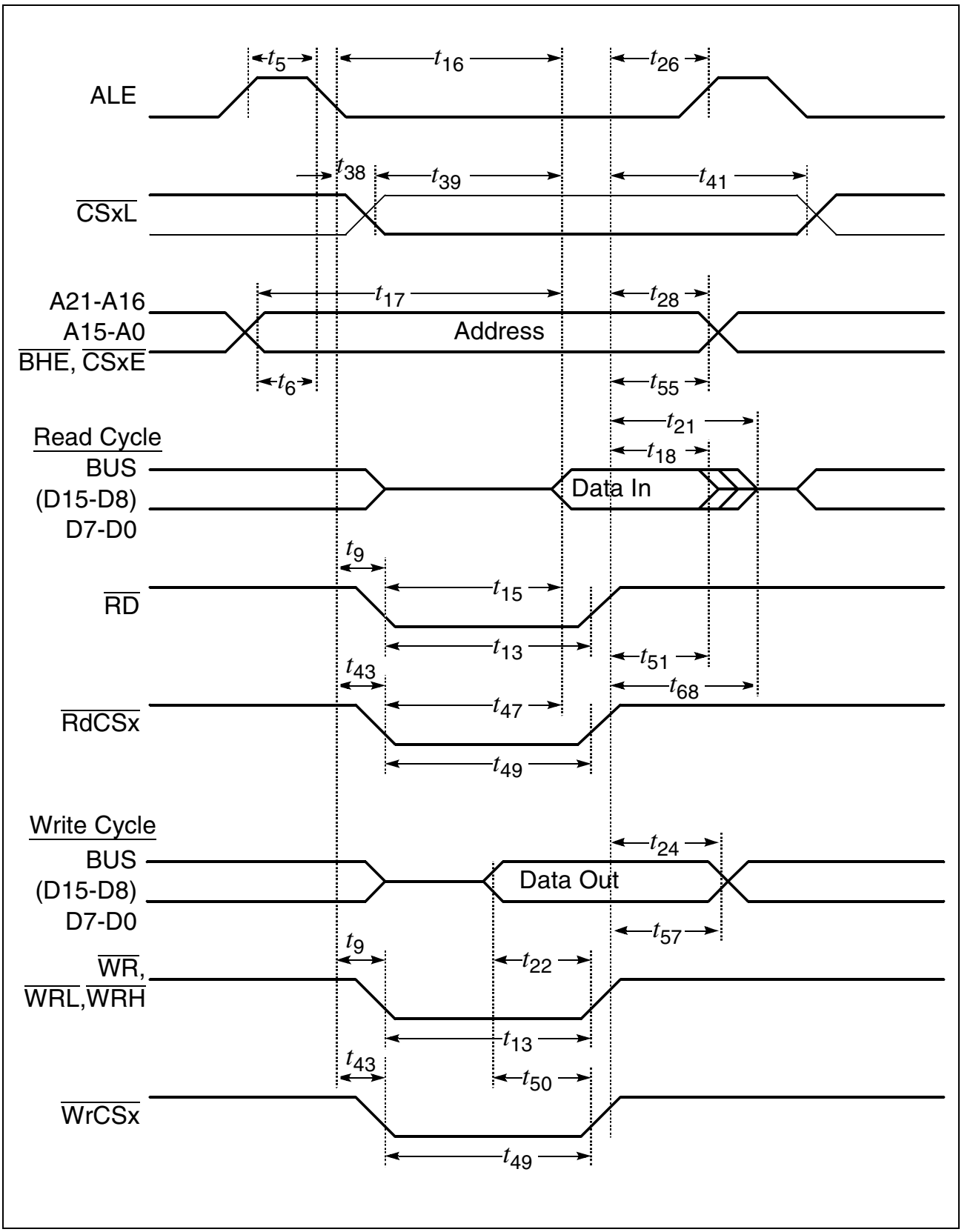

**Figure 22 External Memory Cycle:
Demultiplexed Bus, No Read/Write Delay, Normal ALE**